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Development of Heat Flow Measurement Using Thermal Probe Method in Divertor Simulator MAP-II

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Abstract

We are improving the measurement method of the heat flow (Q) – the sheath potential (V) characteristic for the thermal probe method.

The method of biasing the thermal probe

Time constant to achieve the steady state is 123 ± 18 sec.

The following measurement method is applicable.

- 1. change the bias in a stepwise manner
- 2. deduce the temperature at the steady state by a functional fit of the temperature variation.

Q-V curve and the analysis for T_i and R_E

 Q_{exp} from the temperature gradient has the V-dependent difference (Q_{dif}) compared to Q_{cal} from the calculation using the sheath theory.

The V dependence of Q_{dif} enables us to analyze T_i and R_E .

The error of T_i is large caused by the error in Q_{exp} .

Reliable in-situ calibration of the heat flow is required.

Background

The thermal probe method uses the heat flow (Q) – the sheath potential (V) characteristic in order to deduce the various plasma parameters.

- -- negative ion density [1]
- -- ion temperature [2,3]

[1] E. Stamate et al., Appl. Phys. Lett. 80, 3066 (2002).

[2] H. Matsuura and K. Michimoto, Contrib. Plasma Phys. 44, 677 (2004).

[3] K. Kurihara and S. Kado et al., Trans. Fusion Sci. Tech. (2007) in press

The time resolution of the thermal probe method is poor in nature because of the long transient time in thermal phenomena.

It is necessary to improve the time response of the thermal probe.

The measurement of the time constant to achieve the steady state
The improvement in the Q-V characteristic measurement methods



Heat transfer in thermal probe

Heat transfer in the thermal probe



<u>**1)Heat Conduction**</u> $Q_{\rm C} = -S\kappa \frac{dT_{\rm p}}{dx} \bigg|_{x=Sym}$

κ: thermal conductivity <u>2)Heat Radiation</u> $Q_{\rm R} = S \sigma \left(\varepsilon_{\rm R} T_{\rm p}^{4} - \alpha_{\rm R} T_{\rm n}^{4} \right)$

x=Surface

 $\varepsilon_{\rm R}$: emissivity $\alpha_{\rm R}$: absorptivity

3)Knudsen Effect

$$Q_{\rm K} = Sp \frac{1}{4} \frac{\gamma + 1}{4(\gamma - 1)} \sqrt{\frac{8kT_{\rm n}}{\pi m_{\rm i}}} \alpha_{\rm K} \left| \frac{T_{\rm p}}{T_{\rm n}} - 1 \right|$$

 $\alpha_{\rm K}$: Accommodation coefficient

4) Joule heating

$$Q_{j} = \rho \frac{L}{S} I_{p}^{2}$$

Heat conduction is dominant.

Temperature variation



Considering the sign of $\partial T/\partial t$ doesn't change with any x

$$T(x_1,t) = T(x_1,\infty) + \left\{ T(x_1,0) - T(x_1,\infty) \right\} \exp\left(-\frac{t}{\tau}\right)$$

where

 x_1 : one point in the thermal probe, τ : the time constant to archive the steady state

$$\tau = \frac{1}{\alpha} \frac{4L^2}{\pi^2}$$

(τ depends only on the probe length for a given material)

Q-V characteristic



Q-V characteristic measurement

Two methods for the Q-V characteristic measurement



<u>1. Changing the bias in a stepwise manner: T(x, \cdot) is obtained by fitting.</u>

- The temperature at the transient state is measured.
- Only finite data points can be obtained.

- time response
- **2. Sweeping the bias continuously:** T(x,) is directly measured.
- Continuous Q-V curve can be obtained. (reliable analysis)
- If the sweeping speed is fast against the heat transfer phenomena, the temperature at the steady state is not measured.

The method 1 is more applicable than the method 2 under the long time constant (~125 s under our condition).

Apparatus - thermal probe -





- The probe tip is made of Mo (3 mm ϕ (Left part), 5 mm ϕ (Right part), 40.6 mmL).
- •The thermal probe is equipped with four K type thermo-couples for the temperature gradient measurement and with a fine lead wire for biasing the thermal probe as well as the probe current measurement.
- •The Q-V characteristic and I-V characteristic can be obtained simultaneously.
- •The probe tip is insulated from both Mo cap and Cu heat sink using an boron nitride cover and double capton sheets, respectively.
- •Cu target plate is cooled by an incubator and two external coolant tubes.

Time constant and Virtual probe 1



The deviation of τ becomes small for $\Delta |Q| > 0.1$ W

The length of the real probe is 40.6 mm (Mo part). If the right edge is heat sink, $\tau = 12$ sec from $\tau [s] = 7.55 \times 10^9 L^2$ [mm]

The practical probe length should be interpreted as that of an equivalent probe made of the uniform material

The length of the virtual probe $L = 128 \pm 49$ mm from $L \text{ [mm]} = 1.15 \times 10 \sqrt{\tau}$

Virtual probe 2



Q-V characteristic and T_i



Q_{exp}: heat flow deduced from the temperature gradient in the thermal probe Temperature distribution of TC1-TC2-TC3 is adopted.

 Q_{cal} : heat flow deduced from the sheath theory using experimental data of I_{p_i} . I_p : measured by thermal probe, R_E : interpolated from the database, T_i : assuming $T_i = 0$.



The procedures to deduce T_i and R_E

1. Assuming $Q_{dif} / I_{is.}$ is linear to V in the ion dominant region, the slope *a* and intercept *b* ($Q_{dif} / I_{is} = a \times V + b$) can be deduced from $Q_{dif} / I_{is} - V$.

Adding to the contribution of Q_{dif} , we have

$$Q_{\exp} = I \left\{ (2T_i - V) (1 - R_E) + E_{rec} \right\} + Q_{dif}$$

= $I \left\{ (2T_i - V) (1 - cR_E) + E_{rec} + aV + b \right\}$

**c* is the calibration factor for $R_{\rm E}$, introduced to make use of the V dependence of $R_{\rm E}$.

- **2**. Q-V curve is fitted to the equation in order to obtain $c(T_i \text{ is fixed})$.
- **3**. Q-V curve is fitted again in order to obtain T_i using cobtained in 2.
- **4**. The procedures of 3 and 4 are repeated until T_i and c converge.



Error estimation of T_i



 $T_{\rm i}$ and *c* obtained from the analysis in the fitting region.

 $T_{\rm i} = 0.17 \pm 41.6 \, {\rm eV}$

 $c = 1.0 \pm 0.8$

The error of T_i and c is too large.

This is because the large error in Q_{exp} influences those in a, b, c and T_i .

Without the error in I_{is} and $V, \delta T_i$ is written as



Conclusion

We are improving the measurement method of the *Q*-*V* characteristic for the thermal probe method.

1) The time constant τ and the method of biasing the thermal probe

 τ = 123 ± 18 s, and was independent of the $\Delta |Q|$.

The stepping method is more applicable than the sweeping method.

2) Q-V curve and the analysis for T_i

 Q_{exp} has the difference Q_{dif} compared to Q_{cal} . The process of Q_{dif} is under investigation.

 T_{i} and R_{E} can be analyzed by using the linear V dependence of Q_{dif}/I_{is} . But the errors of T_{i} and c are too big because of the error of Q_{exp} .

We have to improve the accuracy of
$$Q_{exp}$$
.

Future plan

Reliable in-situ calibration of the heat flow

Clarifying the process of the Q_{dif}

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Appendix -differential equation-

<u>Considering the sign of</u> $\partial T/\partial t$ <u>doesn't change with any x</u>

$$\partial T/\partial t \Big|_{x=L} = 0$$
 \longrightarrow $\cos(\lambda L) = 0$
 $\lambda L = \frac{\pi}{2} + n\pi$ $(n \in \mathbf{N})$

The sign of $\partial T / \partial t$ is determined by $\cos(\lambda x)$

Considering the sign of $\partial T / \partial t$ doesn't change with any *x*

(The temperature always varies toward the T(x,

Only n=0 is satisfied with this condition.



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